

MC10116

Triple Line Receiver

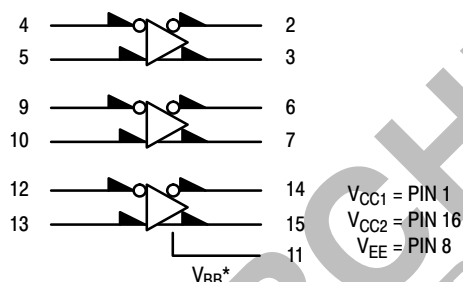
The MC10116 is a triple differential amplifier designed for use in sensing differential signals over long lines. The base bias supply (V_{BB}) is made available at pin 11 to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary.

Active current sources provide the MC10116 with excellent common mode noise rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} (pin 11) to prevent upsetting the current source bias network.

Complementary outputs are provided to allow driving twisted pair lines, to enable cascading of several amplifiers in a chain, or simply to provide complement outputs of the input logic function.

- $P_D = 85 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 2.0 \text{ ns typ}$
- $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

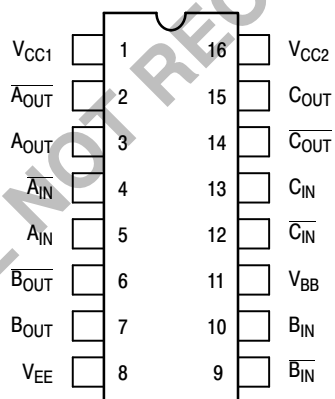
LOGIC DIAGRAM



* V_{BB} to be used to supply bias to the MC10116 only and bypassed (when used) with $0.01 \mu\text{F}$ to $0.1 \mu\text{F}$ capacitor to ground (0 V). V_{BB} can source $< 1.0 \text{ mA}$.

When the input pin with the bubble goes positive, the output pin with the bubble goes positive.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.

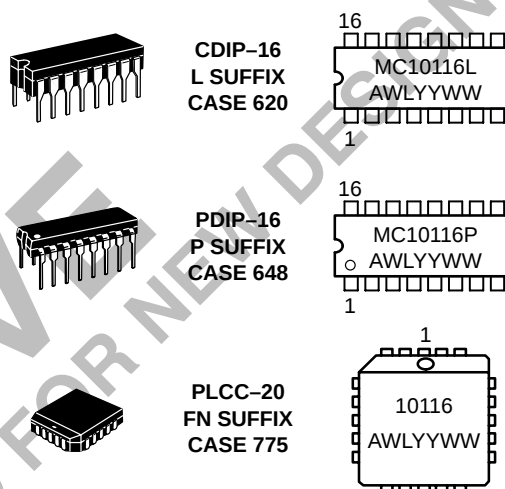
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).



ON Semiconductor

<http://onsemi.com>

MARKING DIAGRAMS



A = Assembly Location
 WL = Wafer Lot
 YY = Year
 WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10116L	CDIP-16	25 Units / Rail
MC10116P	PDIP-16	25 Units / Rail
MC10116FN	PLCC-20	46 Units / Rail

MC10116

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			−30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		23		17	21		23	mAdc
Input Current	I _{inH}	4		150			95		95	μAdc
	I _{CBO}	4		1.5			1.0		1.0	μAdc
Output Voltage Logic 1	V _{OH}	2 3	−1.060 −1.060	−0.890 −0.890	−0.960 −0.960		−0.810 −0.810	−0.890 −0.890	−0.700 −0.700	Vdc
Output Voltage Logic 0	V _{OL}	2 3	−1.890 −1.890	−1.675 −1.675	−1.850 −1.850		−1.650 −1.650	−1.825 −1.825	−1.615 −1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	2 3	−1.080 −1.080		−0.980 −0.980			−0.910 −0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	2 3		−1.655 −1.655			−1.630 −1.630		−1.595 −1.595	Vdc
Reference Voltage	V _{BB}	11	−1.420	−1.280	−1.350		−1.230	−1.295	−1.150	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₂₊	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t _{4−2−}	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t _{4+3−}	3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t _{4−3+}	3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t ₂₊	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
	t ₃₊	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t _{2−}	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
	t _{3−}	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

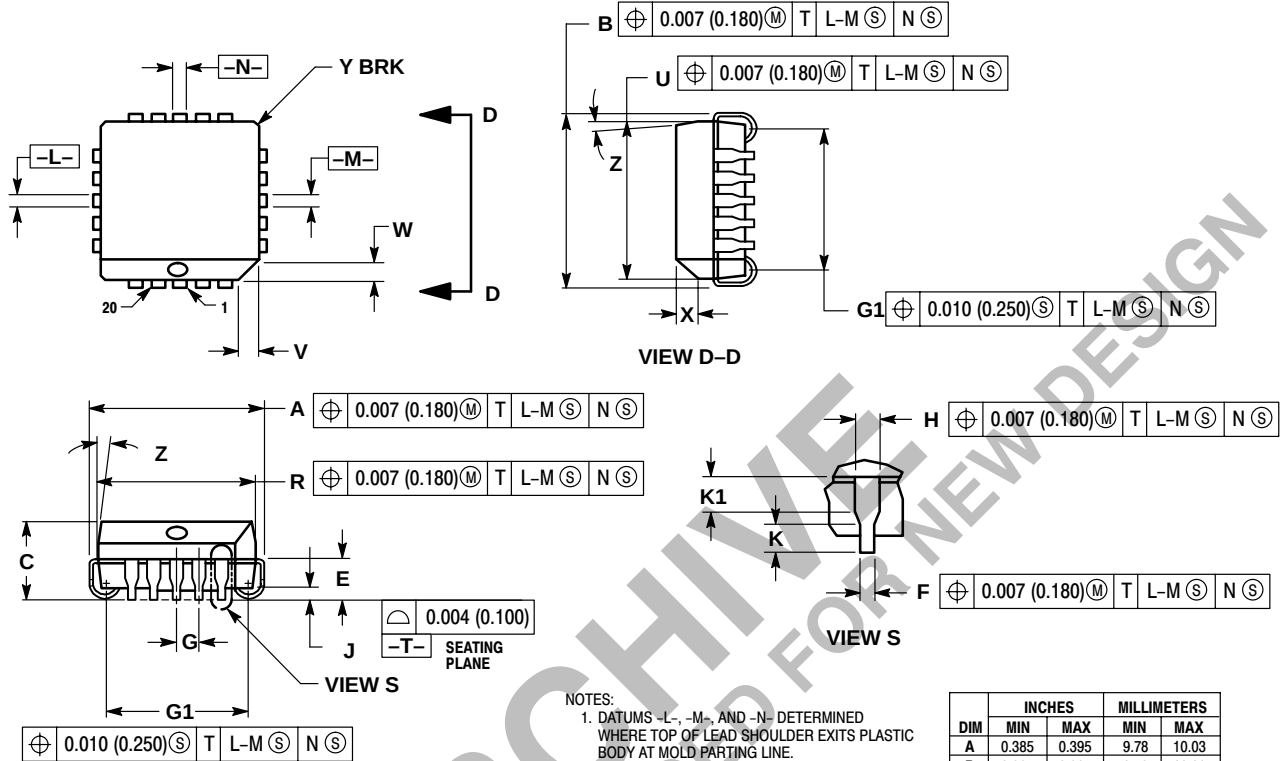
@ Test Temperature			TEST VOLTAGE VALUES (Volts)						(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAMin}	V _{ILAMax}	V _{BB}	V _{EE}	
			−0.890	−1.890	−1.205	−1.500	From Pin 11	−5.2	
			−0.810	−1.850	−1.105	−1.475		−5.2	
			−0.700	−1.825	−1.035	−1.440		−5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAMin}	V _{ILAMax}	V _{BB}	V _{EE}	
Power Supply Drain Current	I _E	8		4, 9, 12			5, 10, 13	8	1, 16
Input Current	I _{inH}	4	4	9, 12			5, 10, 13	8	1, 16
	I _{CBO}	4		9, 12			5, 10, 13	8,4	1, 16
Output Voltage Logic 1	V _{OH}	2	4	9, 12			5, 10, 13	8	1, 16
		3	9, 12	4			5, 10, 13	8	1, 16
Output Voltage Logic 0	V _{OL}	2	9, 12	4			5, 10, 13	8	1, 16
		3	4	9, 12			5, 10, 13	8	1, 16
Threshold Voltage Logic 1	V _{OHA}	2		9, 12	4		5, 10, 13	8	1, 16
		3	9, 12			4	5, 10, 13	8	1, 16
Threshold Voltage Logic 0	V _{OLA}	2		9, 12		4	5, 10, 13	8	1, 16
		3	9, 12		4		5, 10, 13	8	1, 16
Reference Voltage	V _{BB}	11					5, 10, 13	8	1, 16
Switching Times (50Ω Load)					Pulse In	Pulse Out		−3.2 V	+2.0 V
Propagation Delay	t ₄₊₂₊	2			4	2	5, 10, 13	8	1, 16
	t _{4−2−}	2			4	2	5, 10, 13	8	1, 16
	t _{4+3−}	3			4	3	5, 10, 13	8	1, 16
	t _{4−3+}	3			4	3	5, 10, 13	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2			4	2	5, 10, 13	8	1, 16
	t ₃₊	3			4	3	5, 10, 13	8	1, 16
Fall Time (20 to 80%)	t _{2−}	2			4	2	5, 10, 13	8	1, 16
	t _{3−}	3			4	3	5, 10, 13	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to −2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

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PACKAGE DIMENSIONS

PLCC-20
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C

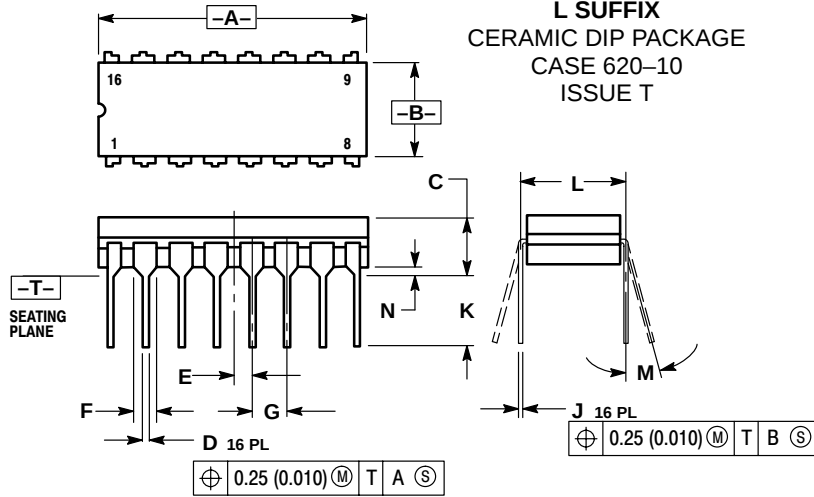


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

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PACKAGE DIMENSIONS

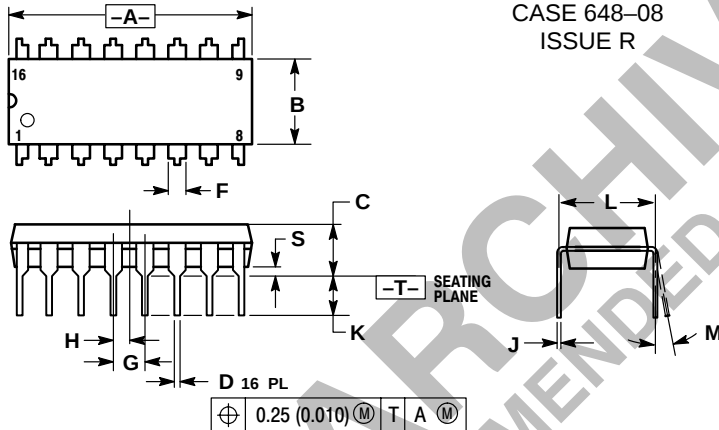
CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

Notes

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Notes

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